

Attorney Docket No: 0492611-0545/MIT-9277CONII IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Seleznev, et al.

Examiner:

Cooke

Serial No.:

10/799,388

Art Unit:

1754

Filing Date:

March 12, 2004

VACUUM PROCESSING FOR FABRICATION OF

Title:

SUPERCONDUCTING THIN FILMS FABRICATED BY METAL-

ORGANIC PROCESSING

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on June 3, 2005.

Susan M. Dinsmore

STATEMENT FILED PURSUANT TO THE DUTY OF DISCLOSURE UNDER 37 CFR §§1.56, 1.97 AND 1.98

Pursuant to the duty of disclosure under 37 C.F.R. §§1.56, 1.97 and 1.98, Applicants respectfully request consideration of this Information Disclosure Statement.

PART I: Compliance with 37 C.F.R. §1.97

(Select A, B or C below)

A.	[]	This Information Disclosure Statement has been filed:				
		(check 1, 2 and/or 3 below)				
	1.	[] within three months of the filing date of the above identified U.S. Patent				
		application;				
	2.	[] within three months of the filing date of the entry of the National Stage, as				
		set forth in 37 C.F.R. §1.491, in an International application; and/or				

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	3.	[]		re the mailing date of the first Office Action on the merits in the ve-identified application.
		No fe		ertification is required.
B.	[X]	This	Inform	ation Disclosure Statement has been filed more than three months
٠.	[22]			ng date of the present application and after the mailing date of this
				Action, but before the mailing date of either a final action under 37
				13 or a Notice of Allowance under 37 C.F.R. §1.311.
			-	2 below)
	1.	[X]		fee of \$180 as set forth in 37 C.F.R. §1.17(p) is enclosed; or
	2.	[]		licants hereby certify, as specified in 37 C.F.R. §1.97(e), that
	2.			ck a or b below)
		a.	[]	each item of information contained in this Information Disclosure
			r 1	Statement was cited in a communication from a foreign Patent
				Office in a counterpart for this application not more than three
				months prior to the filing of this Statement; or
		b.	[]	no item of information contained in this Information Disclosure
			.,	Statement was cited in a communication from a foreign Patent
				Office in a counterpart for this application or, to the knowledge of
				the undersigned after making reasonable inquiry, was known to
				any individual designated in 37 C.F.R. §1.56(c) more than three
				months prior to the filing of this Statement.
		•	rı	items indicated by an asterisk were identified in a recent review of
		c.	[]	related files.
C.	[]	This	Inform	ation Disclosure Statement has been filed after the mailing date of
		eithe	r a Fina	al action under 37 C.F.R. §1.113 or a Notice of Allowance under 37
				11 and before payment of an Issue Fee.
		(chec	k 1, 2,	and 3 below)
	1.	[]		Applicant hereby certifies, as specified in 37 C.F.R. §1.97(e), that:
			(che	ck a or b below)

		a.	[]	each item of information contained in this Information Disclosure
				Statement was cited in a communication from a foreign Patent
				Office in a counterpart for this application not more than three
				months prior to the filing of this Statement.
		b.	[]	no item of information contained in this Information Disclosure
				Statement was cited in a communication from a foreign Patent
				Office in a counterpart for this application or, to the knowledge of
				the undersigned after making reasonable inquiry, was known to
				any individual designated in 37 C.F.R. §1.56(c) more than three
				months prior to the filing of this Statement.
	2.	[]	A Peti	ition requesting consideration of the Information Disclosure
			Staten	nent is attached.
	3.	[]	The P	etition Fee of \$130 as set forth in 37 C.F.R. §1.17(i)(1) is enclosed.
PART	II - Inf	ormatic	on Cited	<u>[</u>
A.	[X]	The A	pplican	t hereby makes of record in the above-identified application the
		refere	nce(s) l	isted on the attached form PTO-1449 (modified). The order of
		preser	ntation o	of the references should not be construed as an indication of the
		impor	tance of	f the references.
B.	[]	The A	Applican	t hereby makes the following additional information of record in the
		above	-identif	ied application:
				•
PART	III: Ex	planati	ion of N	on-English Language References and Remarks Concerning Other
<u>Inforr</u>	nation C	cited		
A.	[]	The fo	ollowing	g is a concise explanation of the relevance of each non-English
		langu	age refe	erence listed on the attached form PTO-1449 (modified):
B.	[]	The fo	ollowing	g are remarks concerning the other information cited:

PART IV: Remarks

- A. [X] Copies of references (check 1 or 2 below)
 - 1. [X] A copy of each of the references cited on the attached form PTO-1449 (modified) is enclosed, except for U.S. patents and U.S. patent application publications for which the submission requirement has been waived by the PTO in the Official Gazette Notice of August 5, 2003, for applications filed after June 30, 2003.
 - 2. [X] Copies of certain of the references cited on the attached form PTO-1449 (modified) are not enclosed because each of these references (indicated by asterisk) was previously cited by or submitted to the Office in a prior application, U.S.S.N. 10/194,561, which prior application is relied upon for an earlier filing date under 35 U.S.C. § 120.
- B. [X] It is respectfully requested that: (check 1, 2, and 3 below)
 - 1. [X] The Examiner consider completely the cited information, along with any other information, in reaching a determination concerning the patentability of the present claims;
 - 2. [X] The enclosed form PTO-1449 be signed by the Examiner to evidence that the cited patent(s) and publication(s) has (have) been fully considered by the Patent and Trademark Office during the examination of this application;
 - 3. [X] The citations for the patent(s) and publication(s) be printed on any patent which issues from this application.
- C. [X] By submitting this Information Disclosure Statement, Applicants make no representation that a search has been performed, of the extent of any search performed, or that more material information may not exist.

- D. [X] By submitting this Information Disclosure Statement, Applicants make no representation that the information cited in the Statement is, or is considered to be, material to patentability as defined in 37 C.F.R. §1.56(b).
- E. [X] By submitting this Information Disclosure Statement, Applicants make no representation that the information cited in the Statement is, or is considered to be, in fact, prior art as defined by 35 U.S.C. §102.
- F. [X] Notwithstanding any statements by Applicants, the Examiner is urged to form his or her own conclusions regarding the relevance of the cited reference(s).

An early and favorable action is hereby requested.

Please charge any additional fees or credit any overpayments to our Deposit Account No. 03-1721.

Respectfully submitted,

Valarie B. Rosen, Ph.D

Registration Number 45,698

CHOATE, HALL & STEWART, LLP Exchange Place 53 State Street Boston, Massachusetts 02109 (617) 248-5000

Dated: June 3, 2005

Form PTO-14	,	epartment of	Atty. Docket:	1 **	lication No.
(REV. 8-83) ₂	JUN 0 6 2005 Comm	erce and Trademark Office	0492611-0545/MIT- 9277CONII	10/799,388	
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